

# SN74ALVCHR162601

## 18-BIT UNIVERSAL BUS TRANSCEIVER

### WITH 3-STATE OUTPUTS

SCES123E – SEPTEMBER 1997 – REVISED FEBRUARY 1999

- **Member of the Texas Instruments Widebus™ Family**
- **EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process**
- **UBT™ (Universal Bus Transceiver) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, Clocked, or Clock-Enabled Mode**
- **Output Ports Have Equivalent 26-Ω Series Resistors, So No External Resistors Are Required**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors**
- **Package Options Include Plastic Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV), and 300-mil Shrink Small-Outline (DL) Packages**

NOTE: For order entry:

The DGG package is abbreviated to G, and the DGV package is abbreviated to V.

### description

This 18-bit universal bus transceiver is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

The SN74ALVCHR162601 combines D-type latches and D-type flip-flops to allow data flow in transparent, latched, clocked, and clock-enabled modes.

Data flow in each direction is controlled by output-enable ( $\overline{OEAB}$  and  $\overline{OEBA}$ ), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. The clock can be controlled by the clock-enable ( $\overline{CLKENAB}$  and  $\overline{CLKENBA}$ ) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if CLKAB is held at a high or low logic level. If LEAB is low, the A data is stored in the latch/flip-flop on the low-to-high transition of CLKAB. When  $\overline{OEAB}$  is low, the outputs are active. When  $\overline{OEAB}$  is high, the outputs are in the high-impedance state.

Data flow for B to A is similar to that of A to B but uses  $\overline{OEBA}$ , LEBA, CLKBA, and  $\overline{CLKENBA}$ .

The outputs include equivalent 26-Ω series resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

DGG, DGV, OR DL PACKAGE  
(TOP VIEW)

$\overline{OEAB}$	1	56	$\overline{CLKENAB}$
LEAB	2	55	CLKAB
A1	3	54	B1
GND	4	53	GND
A2	5	52	B2
A3	6	51	B3
$V_{CC}$	7	50	$V_{CC}$
A4	8	49	B4
A5	9	48	B5
A6	10	47	B6
GND	11	46	GND
A7	12	45	B7
A8	13	44	B8
A9	14	43	B9
A10	15	42	B10
A11	16	41	B11
A12	17	40	B12
GND	18	39	GND
A13	19	38	B13
A14	20	37	B14
A15	21	36	B15
$V_{CC}$	22	35	$V_{CC}$
A16	23	34	B16
A17	24	33	B17
GND	25	32	GND
A18	26	31	B18
$\overline{OEBA}$	27	30	CLKBA
LEBA	28	29	$\overline{CLKENBA}$



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WITH 3-STATE OUTPUTS

SCES123E – SEPTEMBER 1997 – REVISED FEBRUARY 1999

description (continued)

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

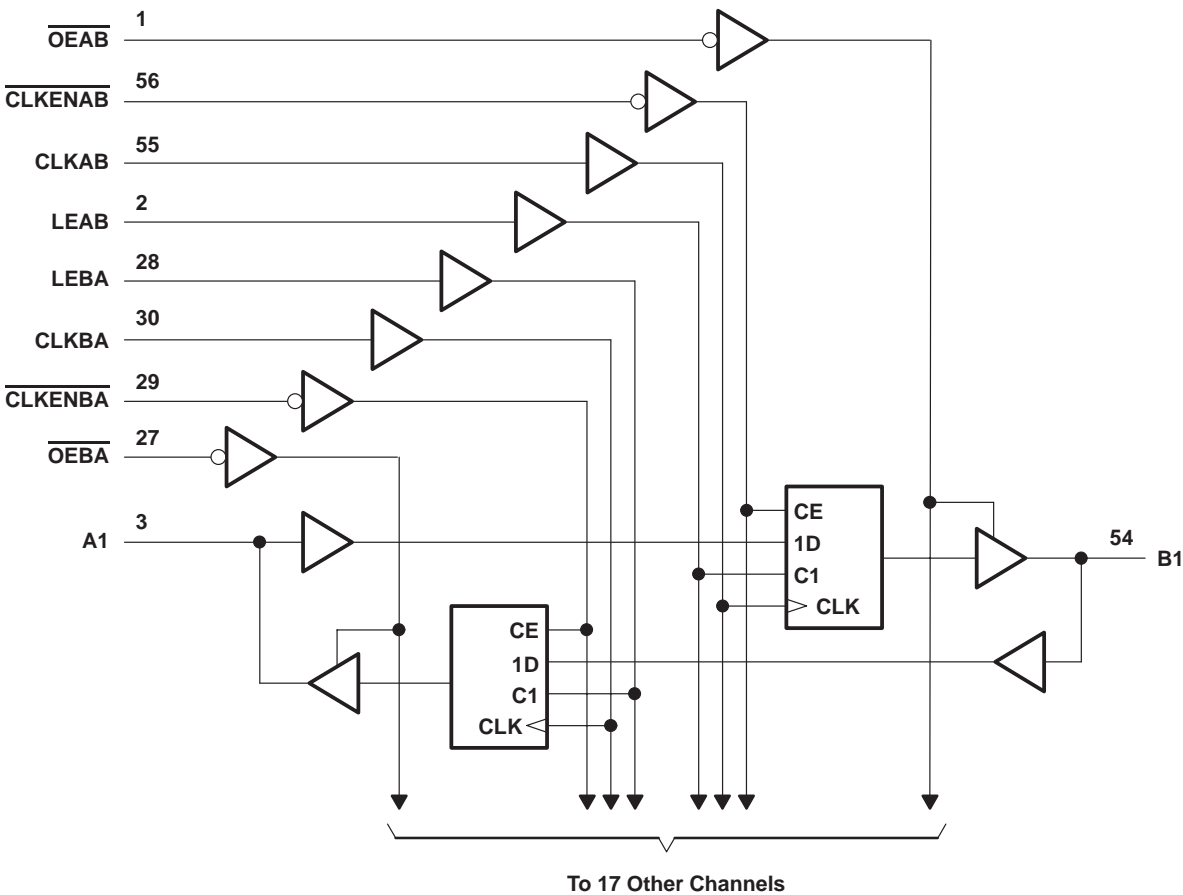
The SN74ALVCHR162601 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE†					
INPUTS					OUTPUT B
CLKENAB	OEAB	LEAB	CLKAB	A	B
X	H	X	X	X	Z
X	L	H	X	L	L
X	L	H	X	H	H
H	L	L	X	X	B <sub>0</sub> ‡
L	L	L	↑	L	L
L	L	L	↑	H	H
L	L	L	L or H	X	B <sub>0</sub> ‡

† A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, CLKBA, and CLKENBA.

‡ Output level before the indicated steady-state input conditions were established

logic diagram (positive logic)



Supply voltage range, $V_{CC}$	.....	-0.5 V to 4.6 V
Input voltage range, $V_I$ : Except I/O ports (see Note 1)	.....	-0.5 V to 4.6 V
I/O ports (see Notes 1 and 2)	.....	-0.5 V to $V_{CC} + 0.5$ V
Output voltage range, $V_O$ (see Notes 1 and 2)	.....	-0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	.....	-50 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	.....	-50 mA
Continuous output current, $I_O$	.....	$\pm 50$ mA
Continuous current through each $V_{CC}$ or GND	.....	$\pm 100$ mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): DGG package	.....	81°C/W
DGV package	.....	86°C/W
DL package	.....	74°C/W

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. This value is limited to 4.6 V maximum.  
3. The package thermal impedance is calculated in accordance with JEDEC 51.

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage		1.65	3.6	V
V <sub>IH</sub>	High-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 × V <sub>CC</sub>		V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7		
		V <sub>CC</sub> = 2.7 V to 3.6 V	2		
V <sub>IL</sub>	Low-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	0.35 × V <sub>CC</sub>		V
		V <sub>CC</sub> = 2.3 V to 2.7 V	0.7		
		V <sub>CC</sub> = 2.7 V to 3.6 V	0.8		
V <sub>I</sub>	Input voltage		0	V <sub>CC</sub>	V
V <sub>O</sub>	Output voltage		0	V <sub>CC</sub>	V
I <sub>OH</sub>	High-level output current	V <sub>CC</sub> = 1.65 V	−2		mA
		V <sub>CC</sub> = 2.3 V	−6		
		V <sub>CC</sub> = 2.7 V	−8		
		V <sub>CC</sub> = 3 V	−12		
I <sub>OL</sub>	Low-level output current	V <sub>CC</sub> = 1.65 V	2		mA
		V <sub>CC</sub> = 2.3 V	6		
		V <sub>CC</sub> = 2.7 V	8		
		V <sub>CC</sub> = 3 V	12		
Δt/Δv	Input transition rise or fall rate		10		ns/V
T <sub>A</sub>	Operating free-air temperature		−40	85	°C



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## 18-BIT UNIVERSAL BUS TRANSCEIVER

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SCES123E – SEPTEMBER 1997 – REVISED FEBRUARY 1999

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS	V <sub>CC</sub>	MIN	TYP†	MAX	UNIT
V <sub>OH</sub>		I <sub>OH</sub> = -100 µA	1.65 V to 3.6 V	V <sub>CC</sub> -0.2			V
		I <sub>OH</sub> = -2 mA	1.65 V	1.2			
		I <sub>OH</sub> = -4 mA	2.3 V	1.9			
		I <sub>OH</sub> = -6 mA	2.3 V	1.7			
			3 V	2.4			
		I <sub>OH</sub> = -8 mA	2.7 V	2			
		I <sub>OH</sub> = -12 mA	3 V	2			
V <sub>OL</sub>		I <sub>OL</sub> = 100 µA	1.65 V to 3.6 V	0.2			V
		I <sub>OL</sub> = 2 mA	1.65 V	0.45			
		I <sub>OL</sub> = 4 mA	2.3 V	0.4			
		I <sub>OL</sub> = 6 mA	2.3 V	0.55			
			3 V	0.55			
		I <sub>OL</sub> = 8 mA	2.7 V	0.6			
		I <sub>OL</sub> = 12 mA	3 V	0.8			
I <sub>I</sub>		V <sub>I</sub> = V <sub>CC</sub> or GND	3.6 V			±5	µA
I <sub>I</sub> (hold)		V <sub>I</sub> = 0.58 V	1.65 V	25			µA
		V <sub>I</sub> = 1.07 V		-25			
		V <sub>I</sub> = 0.7 V	2.3 V	45			
		V <sub>I</sub> = 1.7 V		-45			
		V <sub>I</sub> = 0.8 V	3 V	75			
		V <sub>I</sub> = 2 V		-75			
		V <sub>I</sub> = 0 to 3.6 V‡	3.6 V			±500	
I <sub>OZ</sub> §		V <sub>O</sub> = V <sub>CC</sub> or GND	3.6 V			±10	µA
I <sub>CC</sub>		V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0	3.6 V			40	µA
ΔI <sub>CC</sub>		One input at V <sub>CC</sub> - 0.6 V, Other inputs at V <sub>CC</sub> or GND	3 V to 3.6 V			750	µA
C <sub>i</sub>	Control inputs	V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 V			4	pF
C <sub>io</sub>	A or B ports	V <sub>O</sub> = V <sub>CC</sub> or GND	3.3 V			8	pF

† All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

‡ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

§ For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

**SN74ALVCHR162601**  
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SCES123E – SEPTEMBER 1997 – REVISED FEBRUARY 1999

**timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)**

				V <sub>CC</sub> = 1.8 V		V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f <sub>clock</sub>	Clock frequency			†		150		150		150		MHz
t <sub>w</sub>	Pulse duration	LE high		†		3.3		3.3		3.3		ns
		CLK high or low		†		3.3		3.3		3.3		
t <sub>su</sub>	Setup time	Data before CLK↑		†		2.3		2.4		2.1		ns
		Data before LE↓	CLK high	†		2		1.6		1.6		
			CLK low	†		1.3		1.2		1.1		
		CLKEN before CLK↑		†		2		2		1.7		
t <sub>h</sub>	Hold time	Data after CLK↑		†		0.7		0.7		0.8		ns
		Data after LE↓	CLK high	†		1.3		1.6		1.4		
			CLK low	†		1.7		2		1.7		
		CLKEN after CLK↑		†		0.3		0.5		0.6		

† This information was not available at the time of publication.

**switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 1.8\text{ V}$		$V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$		$V_{CC} = 2.7\text{ V}$		$V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$		UNIT
			MIN	TYP	MIN	MAX	MIN	MAX	MIN	MAX	
$f_{\text{max}}$			†		150		150		150		MHz
$t_{\text{pd}}$	A or B	B or A	†		1	4.8	5.1		1	4.4	ns
	LEAB or LEBA		†		1	5.5	5.8		1	5.1	
	CLKAB or CLKBA		†		1.2	5.9	6.3		1.4	5.4	
$t_{\text{en}}$	$\overline{\text{OEAB}}$ or $\overline{\text{OEBA}}$	B or A	†		1.1	6.3	6.6		1.1	5.6	ns
$t_{\text{dis}}$	$\overline{\text{OEAB}}$ or $\overline{\text{OEBA}}$	B or A	†		1	4.2	5.1		1.6	4.7	ns

† This information was not available at the time of publication.

**operating characteristics,  $T_A = 25^\circ\text{C}$**

PARAMETER			TEST CONDITIONS	$V_{CC} = 1.8\text{ V}$	$V_{CC} = 2.5\text{ V}$	$V_{CC} = 3.3\text{ V}$	UNIT
				TYP	TYP	TYP	
$C_{\text{pd}}$	Power dissipation capacitance	Outputs enabled	$C_L = 0$ , $f = 10\text{ MHz}$	†	56	63	pF
		Outputs disabled		†	12	13	

† This information was not available at the time of publication.

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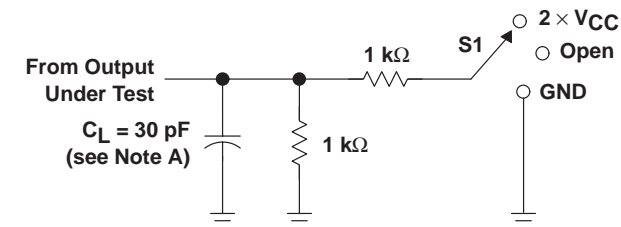
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SCES123E – SEPTEMBER 1997 – REVISED FEBRUARY 1999

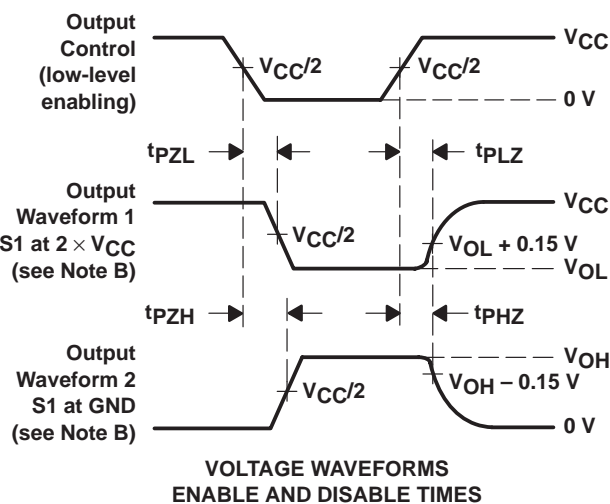
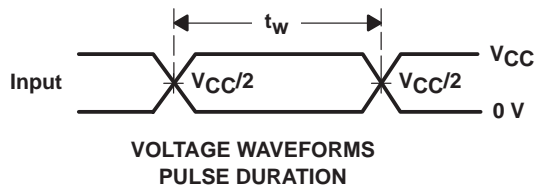
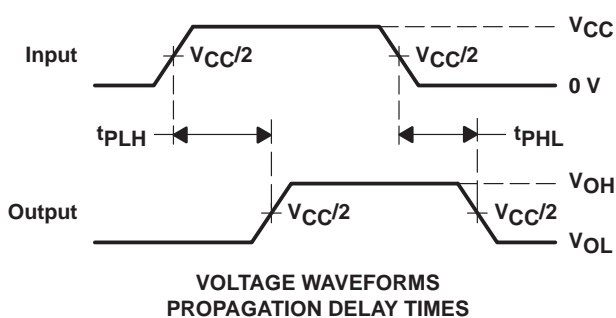
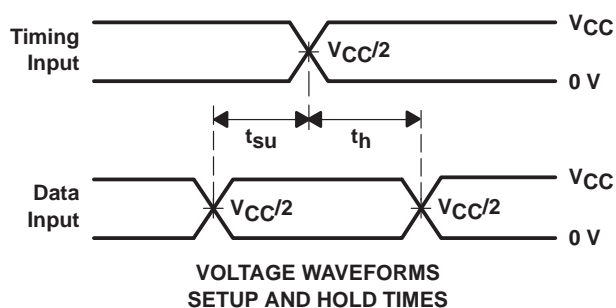
#### PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 1.8\text{ V}$



LOAD CIRCUIT

TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	2 $\times V_{CC}$
$t_{PHZ}/t_{PHL}$	GND

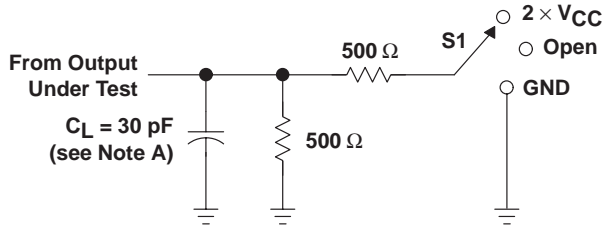


- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2\text{ ns}$ ,  $t_f \leq 2\text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

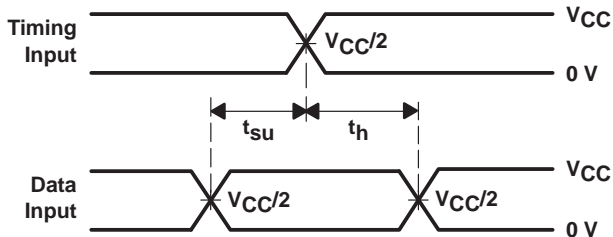
# PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$$

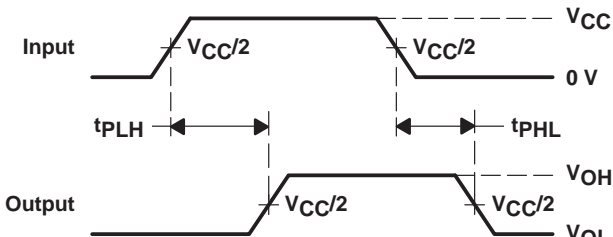


LOAD CIRCUIT

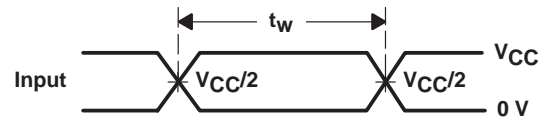
TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	2 $\times V_{CC}$
$t_{PHZ}/t_{PZH}$	GND



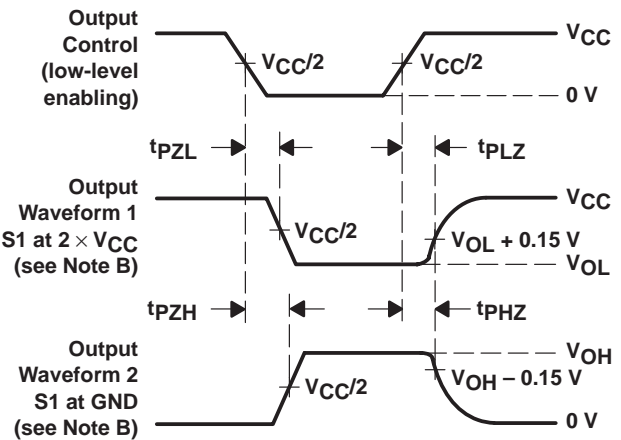
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES

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  - The outputs are measured one at a time with one transition per measurement.
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  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 2. Load Circuit and Voltage Waveforms

# SN74ALVCHR162601

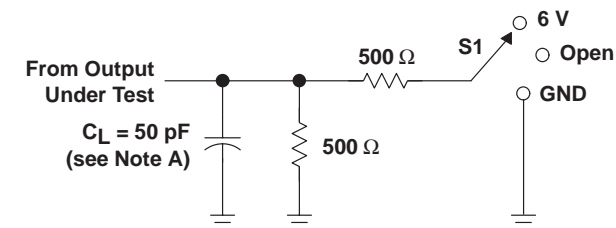
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SCES123E – SEPTEMBER 1997 – REVISED FEBRUARY 1999

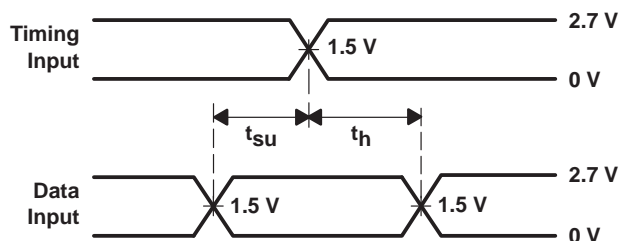
#### PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 2.7 \text{ V AND } 3.3 \text{ V} \pm 0.3 \text{ V}$

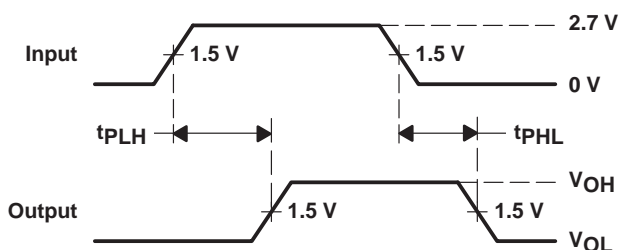


LOAD CIRCUIT

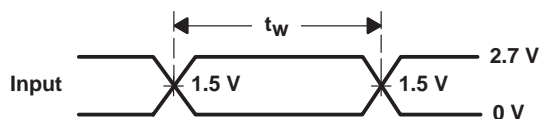
TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	6 V
$t_{PHZ}/t_{PZH}$	GND



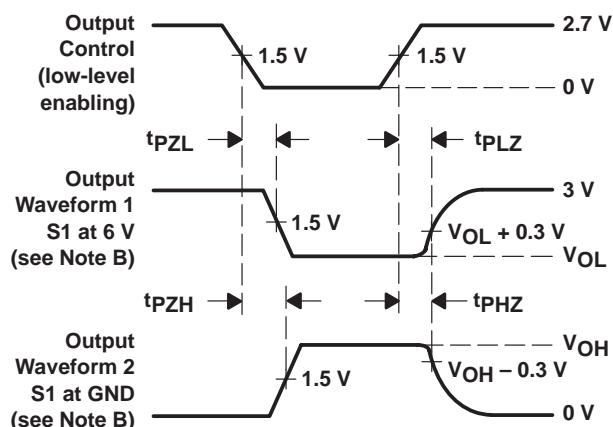
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES

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  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 3. Load Circuit and Voltage Waveforms



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